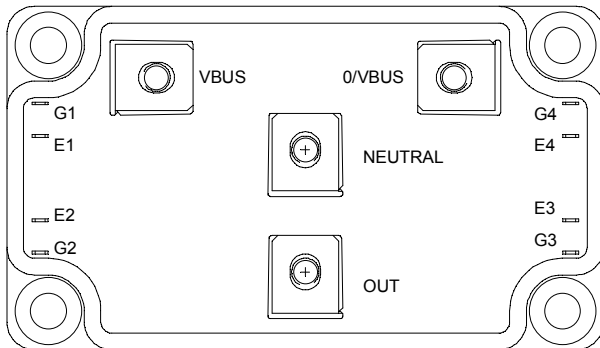
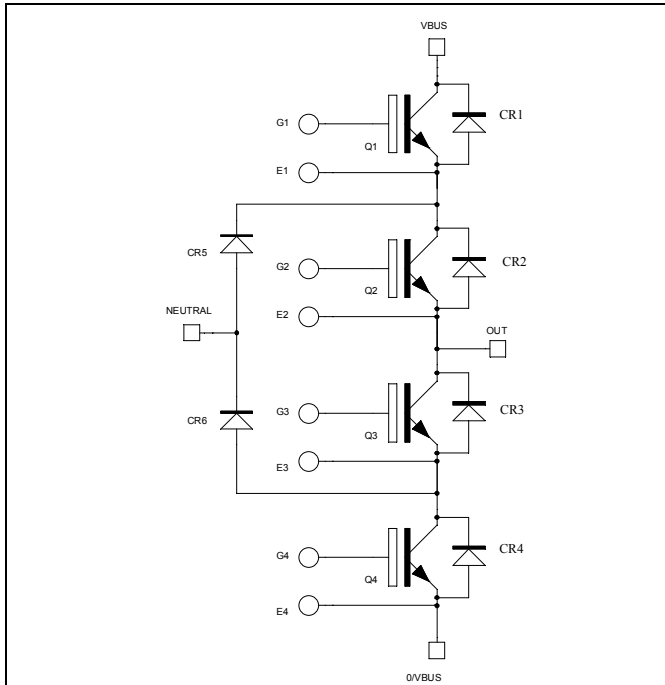


Three level inverter Trench + Field Stop IGBT Power Module

$V_{CES} = 600V$
 $I_C = 150A @ T_c = 80^\circ C$



Application

- Solar converter
- Uninterruptible Power Supplies

Features

- Trench + Field Stop IGBT Technology
 - Low voltage drop
 - Low tail current
 - Switching frequency up to 20 kHz
 - Soft recovery parallel diodes
 - Low diode VF
 - Low leakage current
 - RBSOA and SCSOA rated
- Kelvin emitter for easy drive
- Very low stray inductance
 - Symmetrical design
 - M5 power connectors
- High level of integration

Benefits

- Stable temperature behavior
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive TC of VCEsat
- Low profile
- RoHS Compliant

Q1 to Q4 Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
V_{CES}	Collector - Emitter Breakdown Voltage	600	V
I_C	Continuous Collector Current	$T_c = 25^\circ C$	A
		$T_c = 80^\circ C$	
I_{CM}	Pulsed Collector Current	$T_c = 25^\circ C$	300
V_{GE}	Gate – Emitter Voltage	± 20	V
P_D	Maximum Power Dissipation	$T_c = 25^\circ C$	480
RBSOA	Reverse Bias Safe Operating Area	$T_j = 150^\circ C$	300A @ 550V

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Q1 to Q4 Electrical Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
I_{CES}	Zero Gate Voltage Collector Current	$V_{GE} = 0V, V_{CE} = 600V$			250	μA
$V_{CE(sat)}$	Collector Emitter Saturation Voltage	$V_{GE} = 15V$ $I_C = 150A$	$T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	1.5 1.7	1.9	V
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}, I_C = 2.5\text{ mA}$	5.0	5.8	6.5	V
I_{GES}	Gate – Emitter Leakage Current	$V_{GE} = 20V, V_{CE} = 0V$			400	nA

Q1 to Q4 Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
C_{ies}	Input Capacitance	$V_{GE} = 0V$		9200		pF
C_{oes}	Output Capacitance	$V_{CE} = 25V$		580		
C_{res}	Reverse Transfer Capacitance	$f = 1\text{MHz}$		270		
Q_G	Gate charge	$V_{GE} = \pm 15V, I_C = 150A$ $V_{CE} = 300V$		1.6		μC
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (25°C) $V_{GE} = \pm 15V$ $V_{Bus} = 300V$ $I_C = 150A$ $R_G = 3.3\Omega$		115		ns
T_r	Rise Time			45		
$T_{d(off)}$	Turn-off Delay Time			225		
T_f	Fall Time			55		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (150°C) $V_{GE} = \pm 15V$ $V_{Bus} = 300V$ $I_C = 150A$ $R_G = 3.3\Omega$		130		ns
T_r	Rise Time			50		
$T_{d(off)}$	Turn-off Delay Time			300		
T_f	Fall Time			70		
E_{on}	Turn on Energy	$V_{GE} = \pm 15V$ $V_{Bus} = 300V$	$T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	0.85 1.5		mJ
E_{off}	Turn off Energy	$I_C = 150A$ $R_G = 3.3\Omega$	$T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	4.1 5.3		
I_{sc}	Short Circuit data	$V_{GE} \leq 15V; V_{Bus} = 360V$ $t_p \leq 6\mu\text{s}; T_j = 150^\circ\text{C}$		750		A
R_{thJC}	Junction to Case Thermal Resistance				0.31	$^\circ\text{C/W}$

CR1 to CR4 diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit	
V _{RRM}	Maximum Peak Repetitive Reverse Voltage			600			V	
I _{RM}	Maximum Reverse Leakage Current	V _R =600V	T _j = 25°C			150	μA	
			T _j = 150°C			350		
I _F	DC Forward Current	T _c = 80°C			100		A	
V _F	Diode Forward Voltage	I _F = 100A V _{GE} = 0V	T _j = 25°C		1.6	2	V	
			T _j = 150°C		1.5			
t _{rr}	Reverse Recovery Time	I _F = 100A V _R = 300V di/dt = 2000A/μs	T _j = 25°C		125		ns	
			T _j = 150°C		220			
Q _{rr}	Reverse Recovery Charge		T _j = 25°C		4.7		μC	
			T _j = 150°C		9.9			
E _{rr}	Reverse Recovery Energy		T _j = 25°C		1.1		mJ	
			T _j = 150°C		2.4			
R _{thJC}	Junction to Case Thermal Resistance					0.77	°C/W	

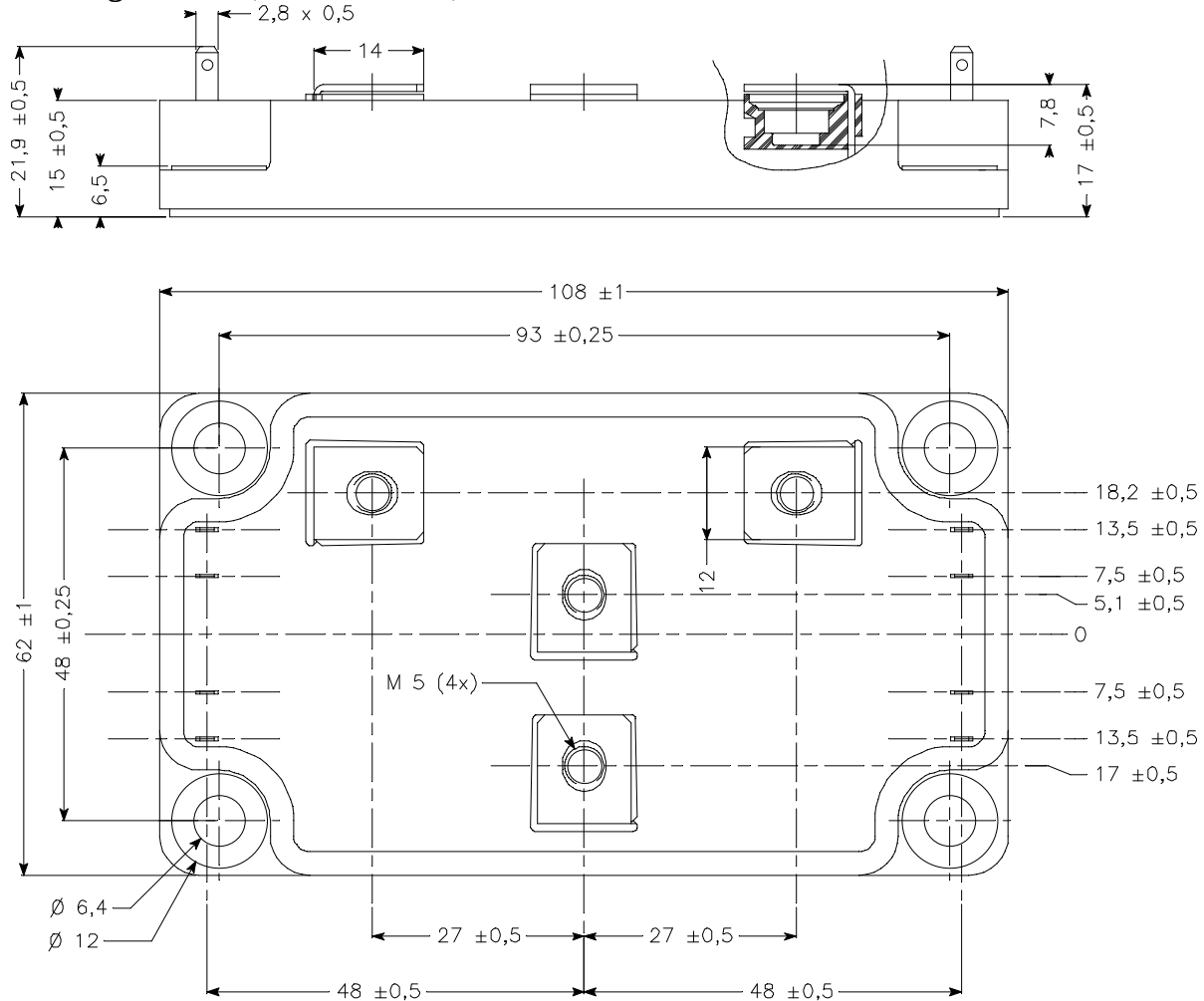
CR5 & CR6 diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit	
V _{RRM}	Maximum Peak Repetitive Reverse Voltage			600			V	
I _{RM}	Maximum Reverse Leakage Current	V _R =600V	T _j = 25°C			150	μA	
			T _j = 150°C			350		
I _F	DC Forward Current		T _c = 80°C		150		A	
V _F	Diode Forward Voltage	I _F = 150A V _{GE} = 0V	T _j = 25°C		1.6	2	V	
			T _j = 150°C		1.5			
t _{rr}	Reverse Recovery Time	I _F = 150A V _R = 300V di/dt = 3000A/μs	T _j = 25°C		130		ns	
			T _j = 150°C		225			
Q _{rr}	Reverse Recovery Charge		T _j = 25°C		6.9		μC	
			T _j = 150°C		14.5			
E _{rr}	Reverse Recovery Energy		T _j = 25°C		1.6		mJ	
			T _j = 150°C		3.5			
R _{thJC}	Junction to Case Thermal Resistance					0.52	°C/W	

Thermal and package characteristics

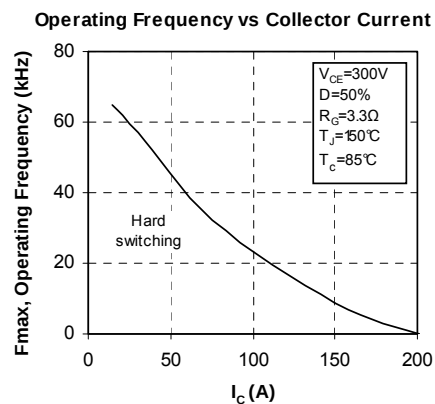
Symbol	Characteristic	Min		Typ	Max	Unit
V _{ISOL}	RMS Isolation Voltage, any terminal to case t = 1 min, I _{isol} < 1mA, 50/60Hz	2500				V
T _J	Operating junction temperature range	-40			175	°C
T _{STG}	Storage Temperature Range	-40			125	
T _C	Operating Case Temperature	-40			100	
Torque	Mounting torque	To heatsink	M6	3	5	N.m
		For terminals	M5	2	3.5	
Wt	Package Weight				280	g

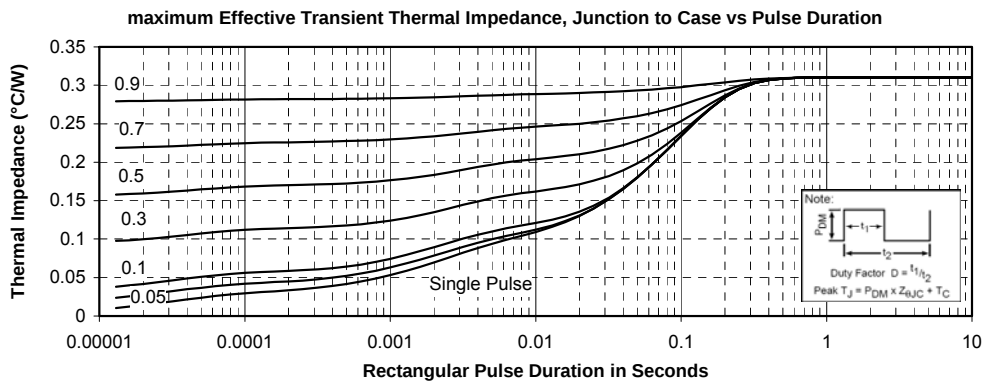
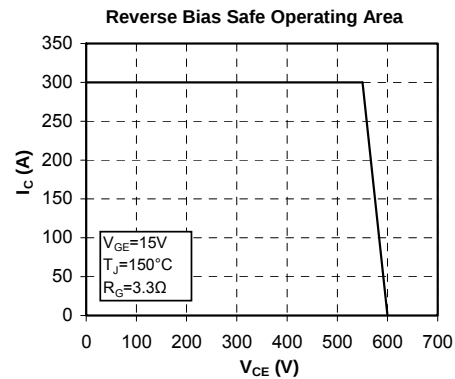
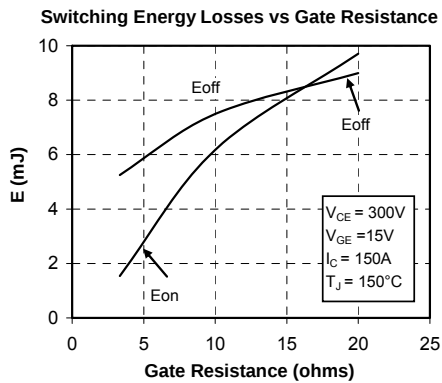
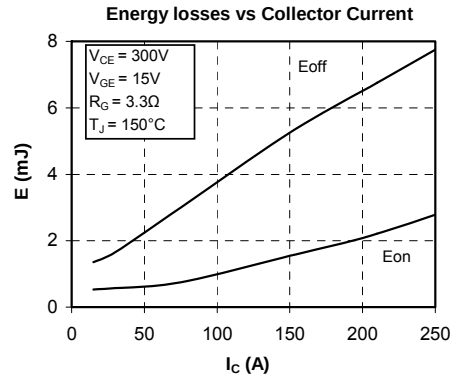
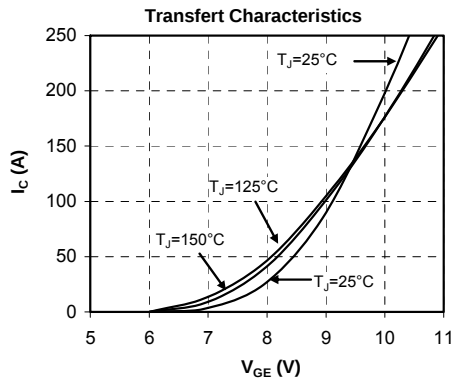
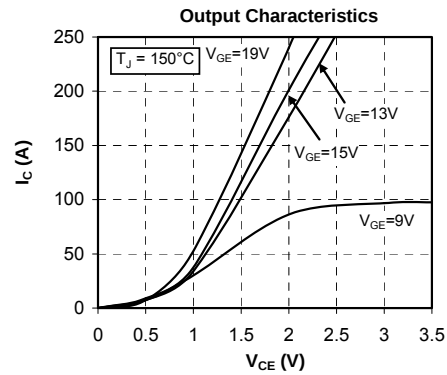
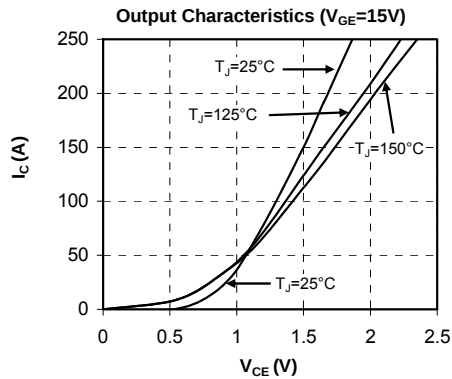
SP6 Package outline (dimensions in mm)



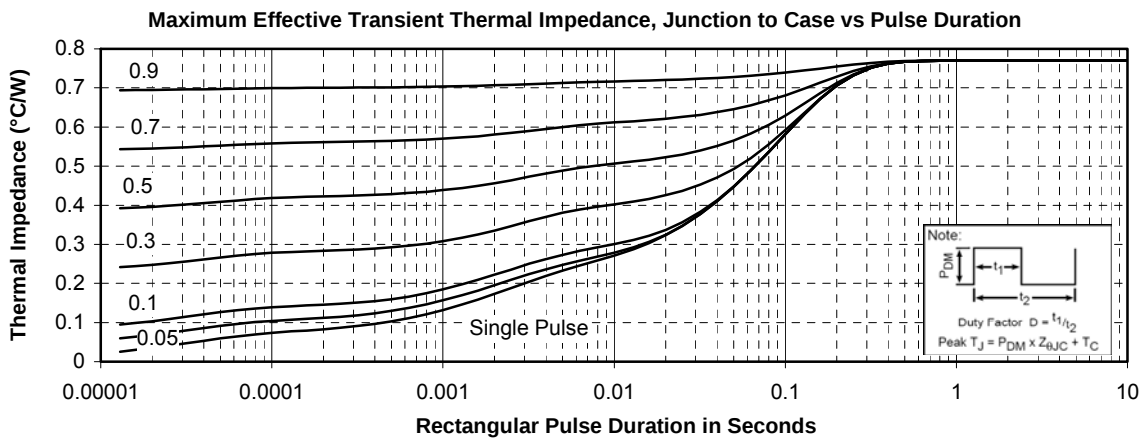
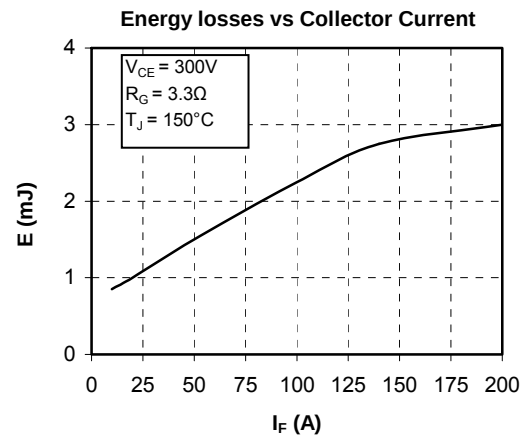
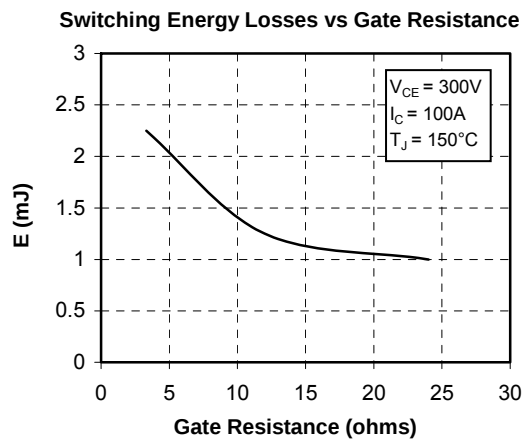
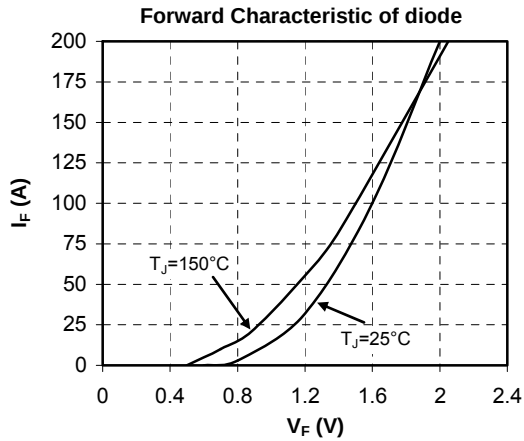
See application note APT0601 - Mounting Instructions for SP6 Power Modules on www.microsemi.com

Q1 to Q4 Typical performance curve

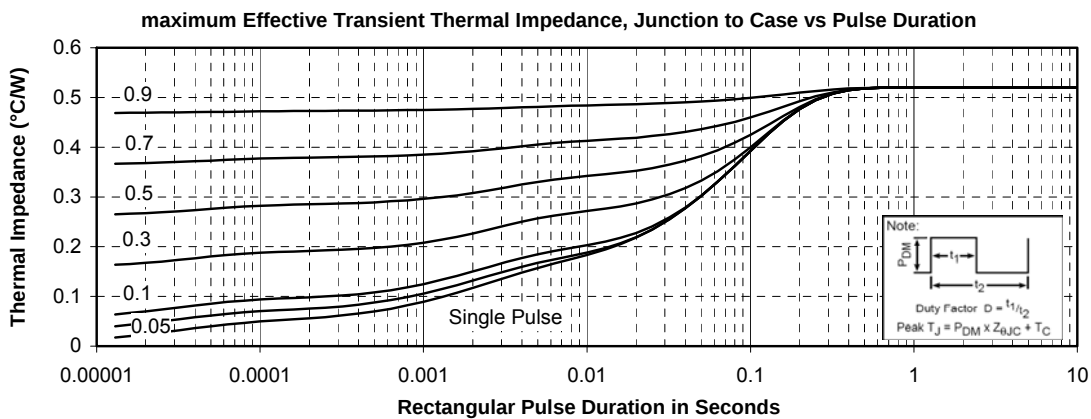
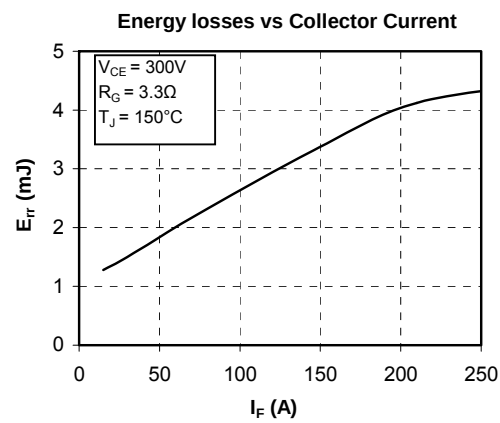
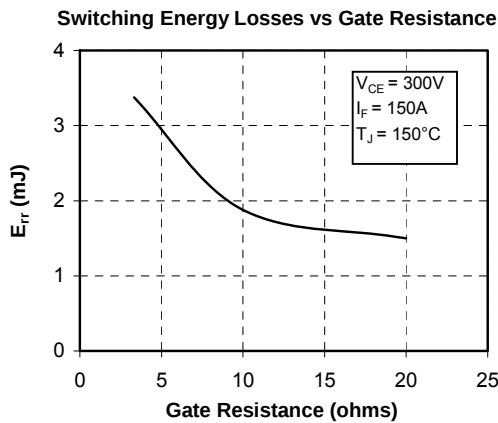
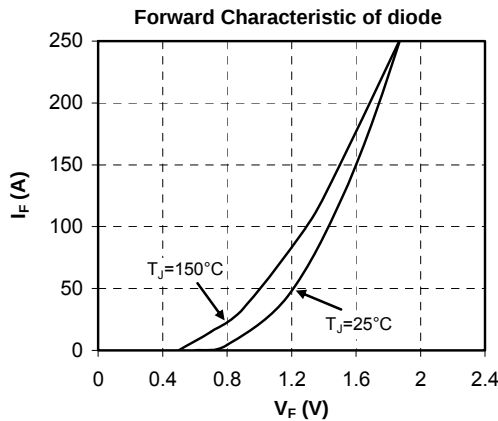




CR1 to CR4 Typical performance curve



CR5 & CR6 Typical performance curve



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